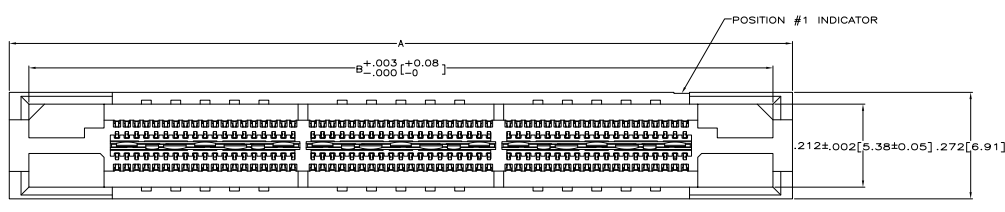
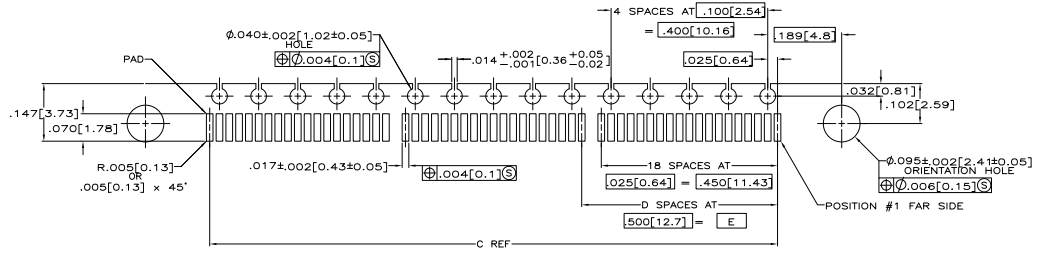
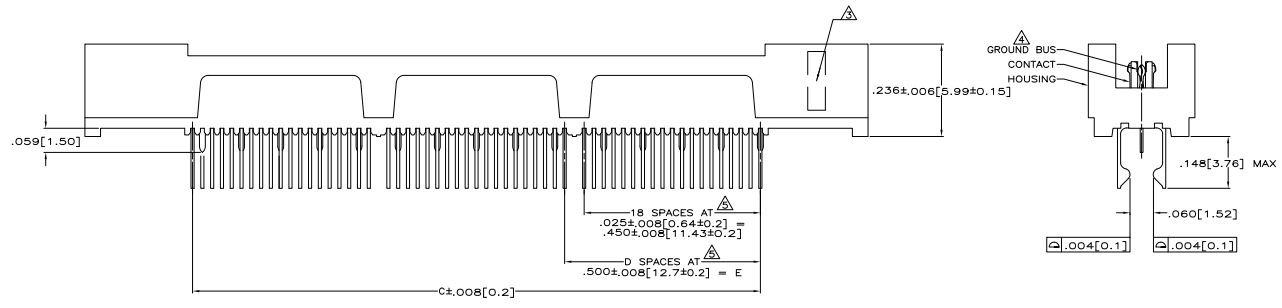


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REV	DATE	DESCRIPTION	BY	CHK	APP
AD 47					
T		REVISED PER ECO-08-030805			



- △ HOUSING: LIQUID CRYSTAL POLYMER, COLOR BLACK.
- CONTACTS: HIGH RELIABILITY COPPER ALLOY.
- GROUND BUSES: PHOSPHOR BRONZE ALLOY, UNS C51100.
- △ CONTACTS & GROUND BUSES: NICKEL UNDERPLATE ALL OVER, MATING SURFACE PLATED TO MEET LEVEL 2 PERFORMANCE REQUIREMENTS OF TE PRODUCT SPECIFICATION 108-1422, SOLDER TAILS PLATED TIN-LEAD.
- △ DATE CODE MARKED IN AREA INDICATED ON SIDE OPPOSITE POSITION #1.
- △ ONE GROUND BUS WITH 5 TAILS PER EACH MODULE.
- △ TOLERANCE NON-ACCUMULATIVE.



RECOMMENDED PC BOARD LAYOUT
 (MIRROR IMAGE ON OPPOSITE SIDE)

PC BOARD THICKNESS	BUS LEADS	E	D	C	B	A	NO OF POS	NO OF PART NUMBER
0.062[1.52]	EXTENDED	3.000[76.2]	6	3.450[87.63]	3.000[76.2]	4.000[101.6]	266	767044-2
0.062[1.52]	EXTENDED	2.500[63.5]	5	2.950[74.93]	3.400[86.36]	3.500[88.9]	228	767044-6
0.062[1.52]	EXTENDED	2.000[50.8]	4	2.450[62.23]	2.900[73.66]	3.000[76.2]	180	767044-0
0.062[1.52]	EXTENDED	1.500[38.1]	3	1.950[49.53]	2.400[60.96]	2.500[63.5]	152	767044-4
0.062[1.52]	EXTENDED	1.000[25.4]	2	1.450[36.83]	1.900[48.26]	2.000[50.8]	114	767044-3
0.062[1.52]	EXTENDED	.500[12.7]	1	.950[24.13]	1.400[35.66]	1.500[38.1]	76	767044-2
0.062[1.52]	EXTENDED	.000[0]	0	.450[11.43]	.900[22.86]	1.000[25.4]	38	767044-1

THIS DRAWING IS A CONTROLLED DOCUMENT

DATE: 108-1422

REVISION: 062[1.57] PCB, MICTOR

SCALE: 1:1

CUSTOMER DRAWING